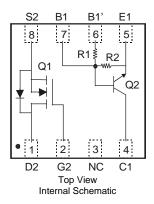


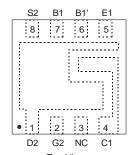


LINEAR MODE CURRENT SINK LED DRIVER

Features

- Primarily Designed for Driving LED/s for Illumination, Signage and Backlighting Applications
- Ideally Suited for Linear Mode Constant Current Applications
- VBE Referenced Current Sink Circuit
- Includes:
 - N-Channel Enhancement Mode MOSFET (Q1)
 - Base Accessible Pre-Biased Transistor (Q2)
- High Voltage Capable (50V)
- Small Form Factor Surface Mount Package
- High Dissipation Capability
- Low Thermal Resistance
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

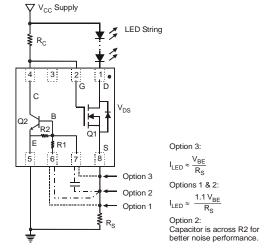




Top View Package Pin-Out Configuration

Mechanical Data

- Case: DFN3030D-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 6
- Ordering Information: See Page 6
- Weight: 0.0172 grams (approximate)



Typical Application Circuit for Linear Mode Current Sink LED Driver

Maximum Ratings: (Q1) @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Drain Source Voltage		V_{DSS}	100	V
Gate-Source Voltage		V _{GSS}	±20	V
Drain Current (Note 3)	$T_A = 25$ °C $T_A = 70$ °C	I _D	1.0 0.8	А
Drain Current (Note 3)	Pulsed	I _{DM}	3.0	A
Body-Diode Continuous Current (Note 3)		I _S	1.0	A

Maximum Ratings: (Q2) @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Supply Voltage	V _{CC}	50	V
Input Voltage	V _{IN}	-5 to +30	V
Output Current (DC)	I _O	100	mA

Thermal Characteristics - Total Device

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3) @T _A = 25°C	P_{D}	0.7	W
Thermal Resistance Junction to Ambient Air (Note 3) @T _A = 25°C	$R_{ hetaJA}$	178	°C/W
Thermal Resistance Junction to Case Air (Note 3) @T _A = 25°C	$R_{ hetaJC}$	30	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 3. Part mounted on FR-4 substrate PC board, with minimum recommended pad layout (see page 6).



Electrical Characteristics: (Q1) @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 4)								
Drain-Source Breakdown Voltage	BV _{DSS}	100			V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current	I _{DSS}			1	μΑ	$V_{DS} = 60V, V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	$V_{GS(th)}$	2.0		4.1	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$		
Static Drain-Source On-Resistance	D			0.85	Ω	$V_{GS} = 10V, I_D = 1.5A$		
Static Dialit-Source Off-Nesistance	R _{DS (ON)}			0.99	5.2	$V_{GS} = 6V$, $I_D = 1A$		
Forward Transconductance	g fs		0.9		S	$V_{DS} = 15V, I_D = 1A$		
Diode Forward Voltage	V_{SD}		0.89	1.1	V	$V_{GS} = 0V, I_{S} = 1.5A$		
DYNAMIC CHARACTERISTICS								
Input Capacitance	C _{iss}		129		pF	.,		
Output Capacitance	Coss	_	14	_	pF	$V_{DS} = 50V, V_{GS} = 0V$ f = 1.0MHz		
Reverse Transfer Capacitance	C _{rss}	_	8	_	pF			
SWITCHING CHARACTERISTICS								
Total Gate Charge	Q_g		3.4					
Gate-Source Charge	Q_{gs}		0.9		nC	$V_{DS} = 50V, V_{GS} = 10V, I_{D} = 1A$		
Gate-Drain Charge	Q_{gd}	_	1	_				
Turn-On Delay Time	t _{d(on)}	_	7.9	_				
Rise Time	t _r		11.4		20	$V_{GS} = 50V, V_{DS} = 10V,$		
Turn-Off Delay Time	t _{d(off)}	_	14.3	_	ns	$I_D = 1A, R_G \approx 6\Omega$		
Fall Time	t _f		9.6					

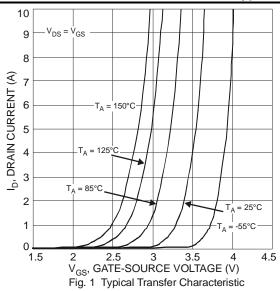
Electrical Characteristics: (Q2) @T_A = 25°C unless otherwise specified

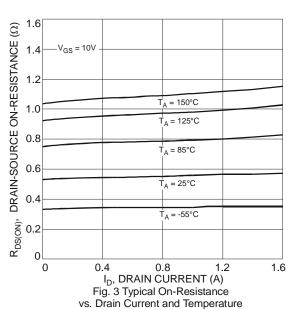
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Input Voltage	$V_{I(off)}$	0.4	=	-	V	$V_{CC} = 5V$, $I_{O} = 100 \mu A$
Imput voltage	$V_{I(on)}$	-	-	1.5	V	$V_{CC} = 0.3V, I_{O} = 5mA$
Output Voltage	$V_{O(on)}$	-	0.05	0.3	V	$I_{O}/I_{I} = 5mA/0.25mA$
Output Current	I _{O(off)}	-	-	0.5	μΑ	$V_{CC} = 50V, V_{I} = 0V$
DC Current Gain	G ₁	80	-	-	-	$V_O = 5V, I_O = 10mA$
Input Resistance	R ₁	3.2	4.7	6.2	kΩ	-
Resistance Ratio	R ₂ /R ₁	8	10	12	-	-
Transition Frequency	f _T	-	260	-	MHz	$V_{CE} = 10V, I_{E} = 5mA,$ f = 100MHz

Notes: 4. Short duration pulse test used to minimize self-heating effect.



Q1 Typical Performance Curves





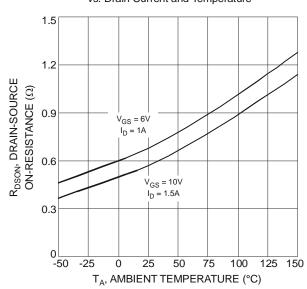
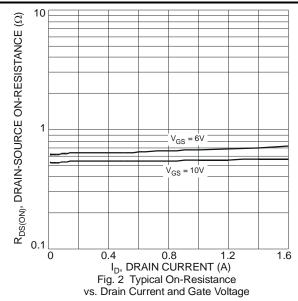
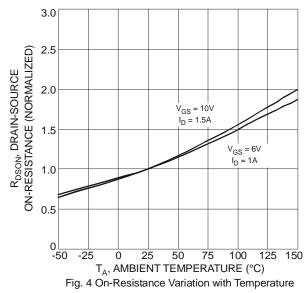


Fig. 5 On-Resistance Variation with Temperature





4.0 3.8 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) 3.6 3.4 3.2 3.0 2.8 l_D = 250μA 2.6 2.4 2.2 2.0 100 125 -50 -25 25 50 75 T_A, AMBIENT TEMPERATURE (°C)

Fig. 6 Gate Threshold Variation vs. Ambient Temperature



Q1 Typical Performance Curves - continued

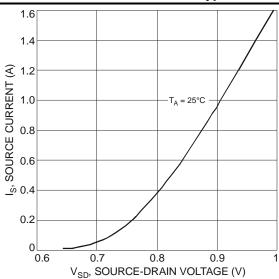


Fig. 7 Source-Drain Diode Forward Voltage vs. Current

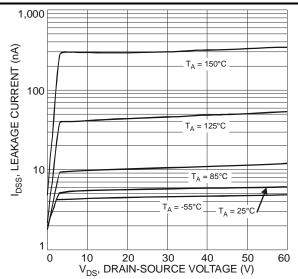
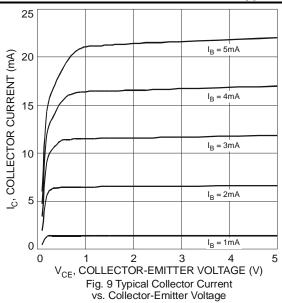
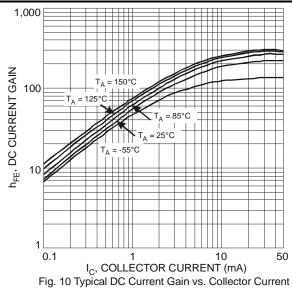


Fig. 8 Typical Leakage Current vs. Drain-Source Voltage

Q2 Typical Performance Curves







Q2 Typical Performance Curves - continued

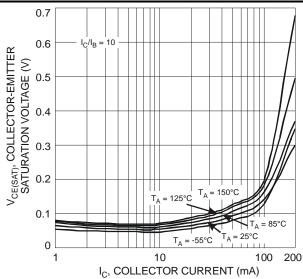


Fig. 11 Typical Collector-Emitter Saturation Voltage vs. Collector Current

Typical Application Circuit

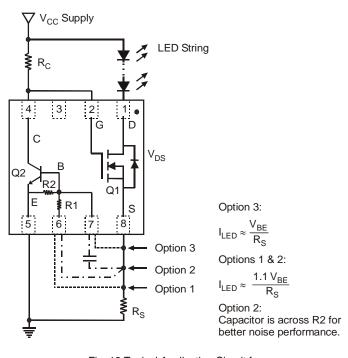


Fig. 12 Typical Application Circuit for Linear Mode Current Sink LED Driver

The DLD101 has been designed primarily for solid state lighting applications, to be used as a current sink circuit solution for LEDs. It features a N-channel MOSFET capable of 1A drive current and a prebiased NPN transistor (which allows direct connection to the base, or via a series base resistor).

Figure 12 shows a typical application circuit diagram for driving an LED or string of LEDs. Note that the pre-biased transistor (Q2) has the option of bypassing the series base resistor by connecting directly to pin 7. The N-MOSFET (Q1) is configured as a V_{BE} referenced current sink and is biased on by $R_{C}.$ The current passed through the LED string, MOSFET and source resistor, develops a voltage across R_{S} that provides a bias to the NPN transistor. Consideration of the expected linear mode power dissipation must be factored into the design, with respect to the DLD101's thermal resistance.

$$V_{DS} = V_{CC} - V_{F LED String} - V_{RS}$$

 $P_{Q1} = V_{DS} * I_{LED String}$

PWM dimming functionality can be effected by either driving the NPN base via an additional resistor (thereby overriding the feedback from R_S) or by pulling the gate of the MOSFET down by direct connection. The PWM control pulse stream can be provided by a micro-controller or simple 555 based circuitry.

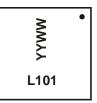


Ordering Information (Note 5)

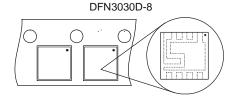
Part Number	Case	Packaging	
DLD101-7	DFN3030D-8	3000/Tape & Reel	

Notes: 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

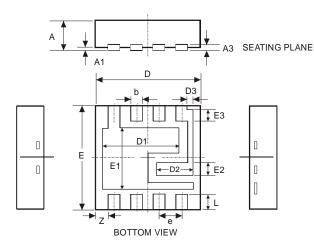
Marking Information



L101 = Product marking code YYWW = Date code marking YY = Last digit of year (ex: 09 for 2009) WW = Week code 01 to 52

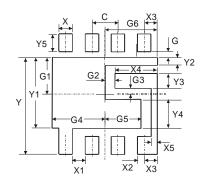


Package Outline Dimensions



DFN3030D-8							
Dim	Min	Max	Тур	Dim	Min	Max	Тур
Α	0.570	0.630	0.600	е	-	-	0.650
A1	0	0.050	0.020	Е	2.950	3.075	3.000
А3	-	-	0.150	E1	1.800	2.000	1.900
b	0.290	0.390	0.340	E2	0.290	0.490	0.390
D	2.950	3.075	3.000	E3	0.175	0.375	0.275
D1	2.175	2.375	2.275	L	0.300	0.40	0.350
D2	0.980	1.180	1.080	Z	-	-	0.355
D3	0.105	0.305	0.205				
All Dimensions in mm							

Suggested Pad Layout



Dimensions	Value (in mm)	Dimensions	Value (in mm)	
С	0.650	X2	0.220	
G	0.150	Х3	0.375	
G1	0.950	X4	1.080	
G2	0.270	X5	0.150	
G3	0.135	Υ	2.600	
G4	1.350	Y1	1.900	
G5	0.925	Y2	0.150	
G6	1.350	Y3	0.390	
Х	0.440	Y4	0.815	
X1	0.210	Y5	0.550	



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